j ·	ì										
		Тур	L#	Hits	Search T xt	DBs	Tim Stamp				
	1	BRS	L1	454075 9	gap or hole or space or spacing or trench	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B					
	2	BRS	L2	279987 1	sacrificial or underfill or fill\$6 or oxide	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2004/06/14 19:05				
	3	BRS	L 3	36602	(coat\$6 or fill\$6 or inject\$6 or deposit\$6 or coat\$6) near4 (sacrificial or underfill or fill\$6 or oxide) near4 (gap or hole or space or spacing or trench)	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2004/06/14 19:05				
	4	BRS	L4	526689		USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B					
	5	BRS	L5		etch\$6 or strip\$6 or lift-off or lift\$6	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2004/06/14 19:06				

<i>x</i>	,	T				
	Туре	L #	Hits	S arch T xt	DBs	Tim Stamp
6	BRS	L6	2562	((coat\$6 or fill\$6 or inject\$6 or deposit\$6 or coat\$6) near4 (sacrificial or underfill or fill\$6 or oxide) near4 (gap or hole or space or spacing or trench)) same ("hard mask" or "etch stop" or barrier or SiN or "silicon nitride") same (etch\$6 or strip\$6 or lift-off or lift\$6)	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2004/06/14 19:06
7	BRS	L7	423790	plasma or (dry near2 etch\$6)	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2004/06/14 19:06
8	BRS	L8	581	or underfill or fill\$6 or oxide) near4 (gap or hole or space or spacing or trench)) same ("hard mask" or "etch stop" or barrier	OFU:	
9	BRS	L 9	415	((((coat\$6 or fill\$6 or inject\$6 or deposit\$6 or coat\$6) near4 (sacrificial or underfill or fill\$6 or oxide) near4 (gap or hole or space or spacing or trench)) same ("hard mask" or "etch stop" or barrier or SiN or "silicon nitride") same (etch\$6 or strip\$6 or lift-off or lift\$6)) same (plasma or (dry near2 etch\$6))) and (@ad<20011107)	OLO,	2004/06/14 19:07